INTERNATIONAL STANDARD



First edition 2004-12-15

Health informatics — Point-of-care medical device communication — PartB0200:NDARD PREVIEW

Transport profile ds. Cable connected

ISO/IEEE 11073-30200:2004

httplnformatique de santé sta Communication entre dispositifs médicaux sur le site des soins tabdaad/iso-ieee-11073-30200-2004 Partie 30200: Profil de transport — Connection par câble



Reference number ISO/IEEE 11073-30200:2004(E)

© ISO/IEEE 2004

iTeh STANDARD PREVIEW (standards.iteh.ai)

Health informatics — Point-of-care medical device communication —

Part 30200: Transport profile — Cable connected

Sponsor

iTeh STANDARD PREVIEW IEEE 1073[™] Standard Committeendards.iteh.ai)

of the ISO/IEEE 11073-30200:2004 https://standards.iteh.ai/catalog/standards/sist/882781fl-bbdc-4a32-b7b9-IEEE Engineering in Medicine and Biology Society 200-2004

Approved 30 January 2000

IEEE-SA Standards Board



PDF disclaimer

This PDF file may contain embedded typefaces. In accordance with Adobe's licensing policy, this file may be printed or viewed but shall not be edited unless the typefaces which are embedded are licensed to and installed on the computer performing the editing. In downloading this file, parties accept therein the responsibility of not infringing Adobe's licensing policy. Neither the ISO Central Secretariat nor the IEEE accepts any liability in this area.

Adobe is a trademark of Adobe Systems Incorporated.

Details of the software products used to create this PDF file can be found in the General Info relative to the file; the PDF-creation parameters were optimized for printing. Every care has been taken to ensure that the file is suitable for use by ISO member bodies and IEEE members. In the unlikely event that a problem relating to it is found, please inform the ISO Central Secretariat or the IEEE at the address given below.

Abstract: A connection-oriented transport profile and physical layer suitable for medical device communications in legacy devices is established. Communications services and protocols consistent with specifications of the Infrared Data Association are defined. These communication services and protocols are optimized for use in patient-connected bedside medical devices. **Keywords:** bedside, Infrared Data Association, IrDA, legacy device, medical device, medical device communications, MIB, patient, SNTP

iTeh STANDARD PREVIEW (standards.iteh.ai)

ISO/IEEE 11073-30200:2004 https://standards.iteh.ai/catalog/standards/sist/882781f1-bbdc-4a32-b7b9cbab91abdaad/iso-ieee-11073-30200-2004

Requests for permission to reproduce should be addressed to either ISO or the IEEE at the addresses below.

ISO copyright office Case postale 56 · CH-1211 Geneva 20 Tel. + 41 22 749 01 11 Fax + 41 22 749 09 47 E-mail copyright@iso.org Web www.iso.org Institute of Electrical and Electronics Engineers Standards Association Manager, Standards Intellectual Property 445 Hoes Lane P. O. Box 1331 Piscataway, NJ 08854 E-mail: stds.ipr@ieee.org Web: www.ieee.org

Copyright © 2004 ISO/IEEE. All rights reserved. Published 15 December 2004. Printed in the United States of America.

IEEE is a registered trademark in the U.S. Patent & Trademark Office, owned by the Institute of Electrical and Electronics Engineers, Incorporated.

 Print:
 ISBN 0-7381-4519-X
 SH95303

 PDF:
 ISBN 0-7381-4520-3
 SS95303

No part of this publication may be reproduced in any form, in an electronic retrieval system or otherwise, without the prior written permission of the publisher.

This ISO/IEEE document is an International Standard and is copyright-protected by ISO and the IEEE. Except as permitted under the applicable laws of the user's country, neither this ISO/IEEE standard nor any extract from it may be reproduced, stored in a retrieval system or transmitted in any form or by any means, electronic, photocopying, recording or otherwise, without prior written permission being secured.

IEEE Standards documents are developed within the IEEE Societies and the Standards Coordinating Committees of the IEEE Standards Association (IEEE-SA) Standards Board. The IEEE develops its standards through a consensus development process, approved by the American National Standards Institute, which brings together volunteers representing varied viewpoints and interests to achieve the final product. Volunteers are not necessarily members of the Institute and serve without compensation. While the IEEE administers the process and establishes rules to promote fairness in the consensus development process, the IEEE does not independently evaluate, test, or verify the accuracy of any of the information contained in its standards.

Use of an IEEE Standard is wholly voluntary. The IEEE disclaims liability for any personal injury, property or other damage, of any nature whatsoever, whether special, indirect, consequential, or compensatory, directly or indirectly resulting from the publication, use of, or reliance upon this, or any other IEEE Standard document.

The IEEE does not warrant or represent the accuracy or content of the material contained herein, and expressly disclaims any express or implied warranty, including any implied warranty of merchantability or fitness for a specific purpose, or that the use of the material contained herein is free from patent infringement. IEEE Standards documents are supplied "AS IS."

The existence of an IEEE Standard does not imply that there are no other ways to produce, test, measure, purchase, market, or provide other goods and services related to the scope of the IEEE Standard. Furthermore, the viewpoint expressed at the time a standard is approved and issued is subject to change brought about through developments in the state of the art and comments received from users of the standard. Every IEEE Standard is subjected to review at least every five years for revision or reaffirmation. When a document is more than five years old and has not been reaffirmed, it is reasonable to conclude that its contents, although still of some value, do not wholly reflect the present state of the art. Users are cautioned to check to determine that they have the latest edition of any IEEE Standard.

In publishing and making this document available, the IEEE is not suggesting or rendering professional or other services for, or on behalf of, any person or entity. Nor is the IEEE undertaking to perform any duty owed by any other person or entity to another. Any person utilizing this, and any other IEEE Standards document, should rely upon the advice of a competent professional in determining the exercise of reasonable care in any given circumstances.

Interpretations: Occasionally questions may arise regarding the meaning of portions of standards as they relate to specific applications. When the need for interpretations is brought to the attention of TEEE, the Institute will initiate action to prepare appropriate responses. Since TEEE standards represent a consensus of concerned interests, it is important to ensure that any interpretation has also received the concurrence of a balance of interests. For this reason, IEEE and the members of its societies and Standards Coordinating Committees are not able to provide an instant response to interpretation requests except in those cases where the matter has previously received formal consideration. At lectures, symposia, seminars, or educational courses, an individual presenting information on IEEE standards shall make it clear that his or her views should be considered the personal views of that individual rather than the formal position, explanation, or interpretation of the IEEE.

Comments for revision of IEEE Standards are welcome from any interested party, regardless of membership affiliation with IEEE. Suggestions for changes in documents should be in the form of a proposed change of text, together with appropriate supporting comments. Comments on standards and requests for interpretations should be addressed to:

Secretary, IEEE-SA Standards Board

445 Hoes Lane

P.O. Box 1331

Piscataway, NJ 08855-1331USA

NOTE — Attention is called to the possibility that implementation of this standard may require use of subject matter covered by patent rights. By publication of this standard, no position is taken with respect to the existence or validity of any patent rights in connection therewith. The IEEE shall not be responsible for identifying patents for which a license may be required by an IEEE standard or for conducting inquiries into the legal validity or scope of those patents that are brought to its attention.

Authorization to photocopy portions of any individual standard for internal or personal use is granted by the Institute of Electrical and Electronics Engineers, Inc., provided that the appropriate fee is paid to Copyright Clearance Center. To arrange for payment of licensing fee, please contact Copyright Clearance Center, Customer Service, 222 Rosewood Drive, Danvers, MA 01923 USA; +1 978 750 8400. Permission to photocopy portions of any individual standard for educational classroom use can also be obtained through the Copyright Clearance Center.

iTeh STANDARD PREVIEW (standards.iteh.ai)

ISO Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

Draft International Standards adopted by the technical committees are circulated to the member bodies for voting. Publication as an International Standard requires approval by at least 75% of the member bodies casting a vote.

A pilot project between ISO and the IEEE has been formed to develop and maintain a group of ISO/IEEE standards in the field of medical devices as approved by Council resolution 43/2000. Under this pilot project, IEEE is responsible for the development and maintenance of these standards with participation and input from ISO member bodies.

Attention is drawn to the possibility that some of the elements of this International Standard may be the subject of patent rights. Neither ISO nor the IEEE shall be held responsible for identifying any or all such patent rights.

ISO/IEEE 11073-30200:2004(E) was prepared by IEEE 1073 Committee of the IEEE Engineering in Medicine and Biology Society. (standards.iteh.ai)

IEEE Introduction

This introduction is not part of ISO/IEEE 11073-30200:2004(E), Health informatics — Point-of-care medical device communication — Part 30200: Transport profile — Cable connected.

ISO/IEEE 11073 standards enable communication between medical devices and external computer systems. They provide automatic and detailed electronic data capture of patient vital signs information and device operational data. The primary goals are to:

- Provide real-time plug-and-play interoperability for patient-connected medical devices
- Facilitate the efficient exchange of vital signs and medical device data, acquired at the point-of-care, in all health care environments

"Real-time" means that data from multiple devices can be retrieved, time correlated, and displayed or processed in fractions of a second. "Plug-and-play" means that all the clinician has to do is make the connection — the systems automatically detect, configure, and communicate without any other human interaction.

"Efficient exchange of medical device data" means that information that is captured at the point-of-care (e.g., patient vital signs data) can be archived, retrieved, and processed by many different types of applications without extensive software and equipment support, and without needless loss of information. The standards are especially targeted at acute and continuing care devices, such as patient monitors, ventilators, infusion pumps, ECG devices, etc. They comprise a family of standards that can be layered together to provide connectivity optimized for the specific devices being interfaced/

ISO/IEEE 11073-30200:2004(E) defines a communications transport profile. This profile is for a cable-connected local area network (LAN) for the interconnection of computers and medical devices. This standard is suitable for new device designs, but is particularly targeted to modifications of legacy devices.

https://standards.iteh.ai/catalog/standards/sist/882781fl-bbdc-4a32-b7b9-The term "legacy devices" refers to equipment that is coaly in the term is a complete the second second

- Already in use in clinical facilities
- In active production at the facilities of medical device manufacturers, or
- Beyond the initial stages of engineering development ____

Specifically, this standard describes connection-oriented communications services and protocols consistent with standards of the Infrared Data Association (IrDA), adapted as appropriate for ISO/IEEE 11073 applications and optimized for use in patient-connected bedside medical devices.

ISO/IEEE 11073-30200:2004(E) is one part of the family of ISO/IEEE 11073 standards. It is compatible with the upper layer ISO/IEEE 11073 standards.

The primary users of this standard are technical personnel who are creating or interfacing with a medical device communications system. Familiarity with the ISO/IEEE 11073 family of standards is recommended. Familiarity with communications and networking technologies is also recommended.

This standard is intended to satisfy the following objectives:

- Allow compatibility with existing medical device communications designs to minimize design risk, a) contain product costs, and simplify field upgrades
- b) Specify hardware and software elements that are available from multiple vendors
- Make use of other computer industry communication technology to allow for continuous cost c) decreases
- Meet the requirements of IEEE Std 1073[™]-1996 d)
- Be compatible with the current published and draft ISO/IEEE standard upper layers e)

Notice to users

Patents

Attention is called to the possibility that implementation of this standard may require use of subject matter covered by patent rights. By publication of this standard, no position is taken with respect to the existence or validity of any patent rights in connection therewith. The IEEE shall not be responsible for identifying patents or patent applications for which a license may be required by to implement an IEEE standard or for conducting inquiries into the legal validity or scope of those patents that are brought to its attention.

Errata

Errata, if any, for this and all other standards can be accessed at the following URL: <u>http://</u><u>standards.ieee.org/reading/ieee/updates/errata/index.html.</u> Users are encouraged to check this URL for errata periodically.

Interpretations

Current interpretations can be accessed at the following URL: <u>http://standards.ieee.org/reading/ieee/interp/index.html.</u>

Participants

iTeh STANDARD PREVIEW

At the time this guide was completed, the Legacy Device Working Group of the IEEE 1073 Committee had the following membership:

Allen Farquhar, Chair				
Todd Cooper	ISO/IFEE 116771ai10200:2004	Ward Silver		
Kenneth J. Fucheps://standards.iteh.ai/catakDietaMoriek/sist/882781fl-bbdc-4a32-b		2-0/Lars Steudesand		
Harald Greiner	cbab91abdaaDanieleNowick73-30200-2004	Jan Wittenber		
	Paul Schluter			

Other individuals who have contributed to this document include

Frank Enslin	Tom Luteran	Bob Meijer
George Kriegl		Carol Pellegrini

The following members of the balloting committee voted on this standard:

Teresa J. Cendrowska Allen Farquhar Ricardo Ruiz Fernandez Kenneth J. Fuchs Harald Greiner Bill Hawley Debra Herrmann Robert J. Kennelly William McMullen

Daniel Nowicki Melvin Reynolds M. Michael Shabot Lars Steubesand When the IEEE-SA Standards Board approved this standard on 30 January 2000, it had the following membership:

Richard J. Holleman, Chair Donald N. Heirman, Vice Chair Judith Gorman, Secretary

Satish K. Aggarwal Dennis Bodson Mark D. Bowman James T. Carlo Gary R. Engmann Harold E. Epstein Jay Forster* Ruben D. Garzon James H. Gurney Lowell G. Johnson Robert J. Kennelly E. G. "Al" Kiener Joseph L. Koepfinger* L. Bruce McClung Daleep C. Mohla Robert F. Munzner Louis-François Pau Ronald C. Petersen Gerald H. Peterson John B. Posey Gary S. Robinson Akio Tojo Hans E. Weinrich Donald W. Zipse

*Member Emeritus

Also included is the following nonvoting IEEE-SA Standards Board liaison:

Robert E. Hebner

Yvette Ho Sang Don Messina IEEE Standards Project Editors

iTeh STANDARD PREVIEW (standards.iteh.ai)

CONTENTS

1.	Overview	1
	1.1 Scope 1.2 Purpose	
	1.3 Standards compatibility	
	1.4 Audience	
2.	References	2
3.	Definitions, acronyms, and abbreviations	4
	3.1 Definitions3.2 Acronyms and abbreviations	
4.	Goals for this standard	7
5.	Architecture	7
	5.1 Topology	7
	5.2 Layering	9
6.	Physical layer iTeh.STANDARD PREVIEW	9
7.	Data link layer	10
	 7.1 IrLAP frame	11
8.	Network layer	15
	8.1 Discovery information	15
	8.2 Information access requirements	
	8.3 Minimum IrLMP multiplexer requirements	
9.	Transport layer	20
	9.1 Maximum transfer unit	
	9.2 Transport service requirements	
	9.3 MDDL service	
10.	Time synchronization	22
11.	Labeling and conformance requirements	23
	11.1 Labeling requirements	
۸	-	
	nex A (normative) Physical layer	
	nex B (informative) Maximum cable length	
Anr	nex C (informative) Modular connectors	37

Annex D (informative) RJ-45 to DB-9 modular adapters	39
Annex E (informative) Detailed rationale for pin assignments	40
Annex F (informative) 10BASE-T	41
Annex G (informative) Power delivery considerations	42
Annex H (informative) Nonisolated BCC and DCC design examples	43
Annex I (informative) Isolated BCC design example	45
Annes J (informative) Optical isolator design example	47
Annex K (informative) Marking guidelines	49
Annex L (informative) IrDA message examples	52
Annex M (normative) IrDA profile	58
Annex N (informative) Time synchronization using SNTP	61
Annex O (informative) Bibliography	69

iTeh STANDARD PREVIEW (standards.iteh.ai)

Health informatics — Point-of-care medical device communication —

Part 30200:

Transport profile — Cable connected

1. Overview

iTeh STANDARD PREVIEW

This standard is divided into 11 clauses, as follows: (standards.iteh.ai)

- Clause 1 provides an overview of this standard.
- Clause 2 lists references to other standards that are useful in applying this standard.
- Clause 3 provides/definitions and abbreviationsds/sist/882781fl-bbdc-4a32-b7b9-
- Clause 4 provides goals for this standardso-ieee-11073-30200-2004
- Clause 5 provides an overview of network topology and layering.
- Clause 6 provides a profile of the physical layer.
- Clause 7 provides a profile of the data link layer.
- Clause 8 provides a profile of the network layer.
- Clause 9 provides a profile of the transport layer.
- Clause 10 describes the optional time synchronization service.
- Clause 11 provides labeling and conformance requirements.

This standard also contains 15 annexes, as follows:

- Annex A describes the physical layer.
- Annex B provides information on the maximum cable length.
- Annex C provides examples of physical link media.
- Annex D provides example schematics for modular adapters.
- Annex E provides a detailed rationale for pin assignments.
- Annex F describes the use of 10BASE-T with this standard.
- Annex G provides a discussion of power delivery considerations.
- Annex H provides examples of simple bedside communications controller (BCC) and device communications controller (DCC) designs.
- Annex I provides an example of an isolated BCC design.
- Annex J provides an optical isolator design example.
- Annex K provides marking guidelines.
- Annex L provides protocol examples, particularly of connection establishment.

- Annex M defines the Infrared Data Association (IrDA) profile specifications adapted from the IrDA implementation guidelines.
- Annex N provides guidelines for using the SNTP time synchronization protocol.
- Annex O provides bibliographical references.

1.1 Scope

The scope of this standard is an IrDA-based, cable-connected local area network (LAN) for the interconnection of computers and medical devices. This standard is suitable for new device designs, but is particularly targeted to modifications of legacy devices.

The term "legacy devices" refers to equipment that is

- Already in use in clinical facilities
- In active production at the facilities of medical device manufacturers, or
- Beyond the initial stages of engineering development

In each of these cases, the degree of effort to add a standardized communications capability might normally be prohibitive, unless special care is taken in developing a suitable standard.

1.2 Purpose

The purpose of this standard is to provide connection-oriented communications services and protocols consistent with IrDA specifications and adapted as appropriate for ISO/IEEE 11073 applications.

(standards.iteh.ai)

1.3 Standards compatibility

ISO/IEEE 11073-30200:2004

This standard is one part/of the family of ISO/JEEE111073 standards.-Ibis-compatible with the ISO/IEEE upper layer standards. cbab91abdaad/iso-ieee-11073-30200-2004

1.4 Audience

The primary users of this standard are technical personnel who are creating or interfacing with a medical device communications system. Familiarity with the ISO/IEEE 11073 family of standards is recommended. Familiarity with communications and networking technologies is also recommended.

2. References

This standard shall be used in conjunction with the following publications. When the following standards are superseded by an approved revision, the revision shall apply.

ANSI/TIA/EIA-232-F-1997, Interface Between Terminal Equipment and Data Circuit-Terminating Equipment Employing Serial Binary Data Interchange.¹

ANSI/TIA/EIA-561-1990, Simple 8 Position Non-Synchronous Interface Between Data Terminal Equipment and Data Circuit-Terminating Equipment Employing Serial Binary Data Interchange.

¹ANSI publications are available from the Sales Department, American National Standards Institute, 25 West 43rd Street, 4th Floor, New York, NY 10036, USA (http://www.ansi.org/).

ANSI/TIA/EIA-562-1989, Electrical Characteristics for an Unbalanced Digital Interface.

ANSI/TIA/EIA-568-A-1995, Commercial Building Telecommunications Cabling Standard.

IEC 60603-7: 1996, Connectors for Frequencies Below 3 MHz for Use with Printed Circuit Boards—Part 7: Detailed specification for connectors, 8-way, including fixed and free connectors with common mating features, with assessed quality.²

IEC 60417-1:1998, Graphical Symbols for Use on Equipment—Part 1: Overview and Application.

IEEE Std 802.3[™], IEEE Standard for Local Area Networks—Carrier Sense Multiple Access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications.^{3, 4}

IEEE Std 1073[™]-1996, IEEE Standard for Medical Device Communications—Transport Profiles—Overview and Framework.

IEEE Std 1073.3.1[™]-1994, IEEE Standard for Medical Device Communications—Transport Profile—Connection Mode.⁵

IEEE Std 1073.4.1[™]-1994, IEEE Standard for Medical Device Communications—Physical Layer Interface—Cable Connected.⁶

IrDA, Link Management Protocol, Version 1.1, Jan. 23, 1996.⁷

IrDA, Serial Infrared Link Access Protocol (IrLAP), Version 1.1, June 16, 1996.

(standards.iteh.ai) IrDA, Tiny TP: A Flow-Control Mechanism for use with IrLMP, Version 1.1, Oct. 20, 1996.

ISO/IEC 8877:1992(E), Information technology Telecommunications and information exchange between systems—Interface connector and contact assignments for ISDN Basic Access Interface located at reference could be abdaed iso-ieee-11073-30200-2004

RFC-1305, Internet Engineering Task Force, Network Working Group Report, Mar. 1992, "Network Time Protocol Specification, Implementation and Analysis," Mills, D., University of Delaware.^{8,9}

RFC-2030, Internet Engineering Task Force, Network Working Group Report, Oct. 1996, "Simple Network Time Protocol (SNTP) Version 4 for IPv4, IPv6 and OSI," Mills, D., University of Delaware.

²IEC publications are available from the Sales Department of the International Electrotechnical Commission, Case Postale 131, 3, rue de Varembé, CH-1211, Genève 20, Switzerland/Suisse (http://www.iec.ch/). IEC publications are also available in the United States from the Sales Department, American National Standards Institute, 11 West 42nd Street, 13th Floor, New York, NY 10036, USA.
³IEEE publications are available from the Institute of Electrical and Electronics Engineers, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331, USA (http://www.standards.ieee.org/).

⁴The IEEE standards or products referred to in this clause are trademarks of the Institute of Electrical and Electronics Engineers, Inc. ⁵IEEE Std 1073.3.1-1994 has been withdrawn; however, copies can be obtained from Global Engineering, 15 Inverness Way East, Englewood, CO 80112-5704, USA, tel. (303) 792-2181 (http://global.ihs.com/).

⁶IEEE Std 1073.4.1-1994 has been withdrawn; however, copies can be obtained from Global Engineering, 15 Inverness Way East, Englewood, CO 80112-5704, USA, tel. (303) 792-2181 (http://global.ihs.com/).

⁷IrDA publications are available at http://www.irda.org.

⁸Internet Engineering Task Force publications are available at http://www.ietf.org/.

⁹Information on the Network Time Protocol is available at http://www.eecis.udel.edu/~ntp/.